

Express Mail Label No. EV 319223042 US

PATENT APPLICATION
Docket No. 11675.163.2



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Terry N. Williams

Serial No.: 09/761,375

Filed: January 16, 2001

For: BUFFERED RESIST PROFILE ETCH OF A
FIELD EMISSION DEVICE STRUCTURE

Examiner: Jurie Yun

Confirmation No.: 5328

AMENDMENT AND RESPONSE

Mail Stop: RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed from the United States Patent and Trademark Office on February 26, 2003, please enter the following amendments and remarks into the file of the above-identified application.

Amendments made herein are in accordance with the permissive rules signed by Steven Kunin, Deputy Commission for Patent Examination Policy (see <http://www.uspto.gov/web/offices/pac/dapp/opla/preognotice/revamdtprac.htm>) on January 31, 2003.

*9/Amend
Jury
S. Macley
7-16-03*

) Art Unit
) 2882

RECEIVED
JUN 24 2003
TECHNOLOGY CENTER 2800